

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	EXECUTIVE ORDER 9424, CONFIRMATORY LICENSE												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>The Pennsylvania State University</td> <td>10/20/2011</td> </tr> </tbody> </table>		Name	Execution Date	The Pennsylvania State University	10/20/2011								
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RECEIVING PARTY DATA													
<table border="1"> <tr> <td>Name:</td> <td>National Science Foundation</td> </tr> <tr> <td>Street Address:</td> <td>4201 Wilson Blvd</td> </tr> <tr> <td>Internal Address:</td> <td>Room 1265</td> </tr> <tr> <td>City:</td> <td>Arlington</td> </tr> <tr> <td>State/Country:</td> <td>VIRGINIA</td> </tr> <tr> <td>Postal Code:</td> <td>22230</td> </tr> </table>		Name:	National Science Foundation	Street Address:	4201 Wilson Blvd	Internal Address:	Room 1265	City:	Arlington	State/Country:	VIRGINIA	Postal Code:	22230
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PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Patent Number:</td> <td>7090889</td> </tr> </tbody> </table>		Property Type	Number	Patent Number:	7090889								
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Patent Number:	7090889												
CORRESPONDENCE DATA													
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Invention Title: Processing Parameters for Thin Film Deposition of MgB2 on Silicon Substrate

Inventor(s): Z-K. Liu, Z-J. Liu, X. Xi

U.S. Filing/Issue Date: 8/15/06

Patent or Application Serial No.: 7,090,889

Grant/Contract Number(s): N00014-00-1-0294

Foreign Applications filed/intended in (countries): _____

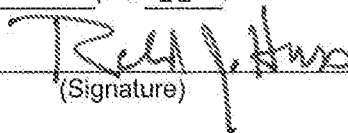
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Signed this 20th day of October, 20 11.

By Ronald J. Huss
(Institutional Business Official)


(Signature)

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(Grantee/Contractor Organization)

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